

Model No. <u>TM128160EKFWG1</u>

Prepared by: Date: Checked by: Date: Verified by: Date: Approved by: Date:

TIANMA MICROELECTRONICS CO., LTD

Ver 10

REVISION RECORD

Date	Ver.	Ref. Page	Revision No.	Revision Items

1. General Specifications:

1.1 Display type: COLOR STN

1.2 Display color*¹:

Display color: 65K COLOR

Background*²: Black (Red, Green, Blue dots are off state)

1.3 Polarizer mode: Transmissive/Negative

1.4 Viewing Angle: 6:00

1.5 Driving Method: 1/160 Duty 1/5 Bias

1.6 Backlight Type: LED (3 LAMPS)

Backlight Color: WHITE

1.7 Controller: S6B33B0A03-B0CY

1.8 Data Transfer: 8/16 Bits Parallel or 3/4-PIN Serial Interface

1.9 Operating Temperature: $-20 \sim +70 ^{\circ}$ C

Storage Temperature: $-30 \sim +80 ^{\circ}\text{C}$

1.10 Power Supply Voltage: VDD=3.0V

1.11 LCD Operating Voltage: VLCD=16.8V

1.12 Outline Dimensions: Refer to outline drawing on next page

1.13 Dot Matrix: 128×3 (RGB)×160 Dots

1.14 Dot Size: $0.227(R+G+B) \times 0.215(mm^2)$

1.15 Dot Pitch: $0.237 \times 0.225 \text{ (mm}^2\text{)}$

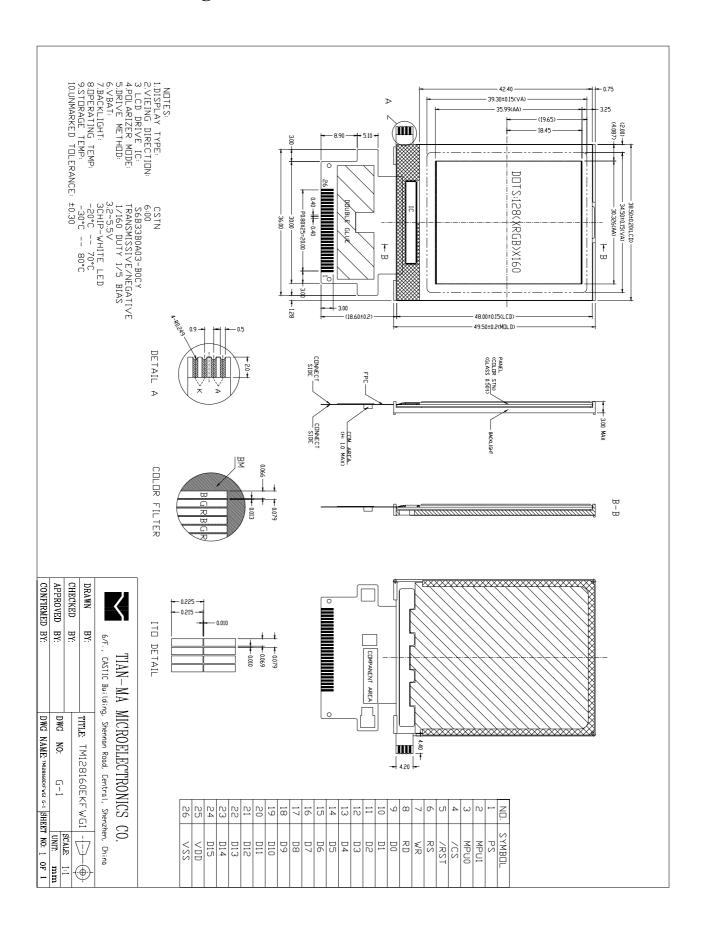
1.16 Weight: TBD*³

^{*1} Color tone is slightly changed by temperature and driving voltage.

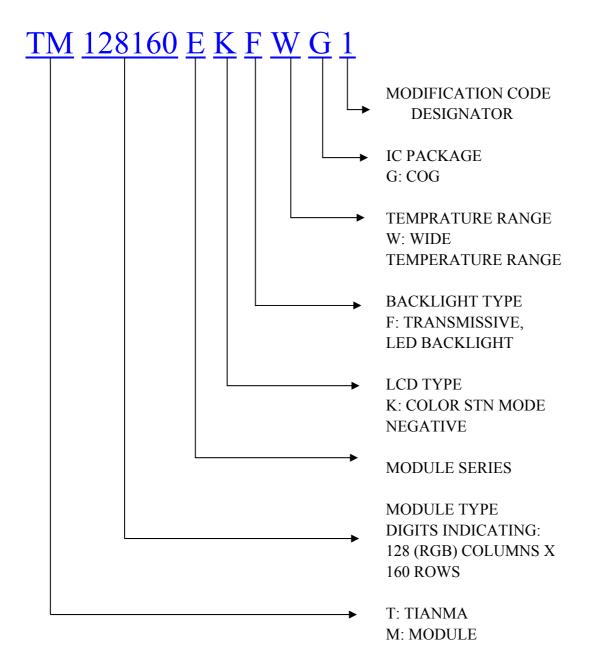
^{*2} Color tone will be changed by backlight.

^{*&}lt;sup>3</sup> TBD: To Be Determined.

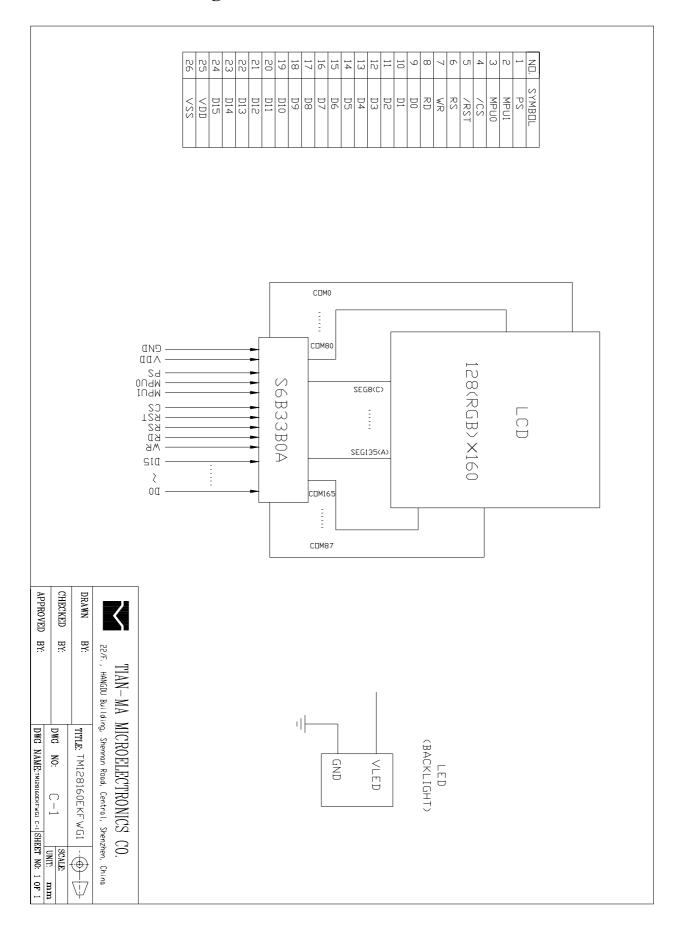
2. Outline Drawing



3. LCD Module Part Numbering System



4. Circuit Block Diagram



5. Absolute Maximum Ratings

Ta=25℃

Item	Symbol	Min.	Max.	Unit	Remark	
Power Supply Voltage	V _{DD} -V _{SS}	-0.3	+4.6	V		
LCD Driving Voltage	VLCD	-0.3	+20.0	v		
Operating Temperature Range	Тор	-20	+70	°C	No	
Storage Temperature Range	Тѕт	-30	+80		Condensation	

6. Electrical Specifications and Instruction Code

6.1 Electrical characteristics

Vss=0V, Ta=25℃

Iter	n	Symbol	Min.	Тур.	Max.	Unit
Supply V (Log	_	V _{DD} -V _{SS}	+3.1	+3.6	+4.5	V
Supply V (LCD I	_	VLCD	- 16.8		-	V
Input	High	V_{IH} $(V_{DD}=3.0)$	$0.8 \mathrm{V}_\mathrm{DD}$	-	$V_{ m DD}$	V
Signal Voltage	Low	V_{IL} $(V_{DD}=3.0)$	0	-	$0.2V_{DD}$	V
Supply of (Log		I_{DD} $(V_{DD}-V_{SS}=3.0V)$	-	-	2.5	mA
Oscill		$ m f_{osc}$	220	-	330	KHz
Supply Voltage (LED)		$ m V_{LED}$	-	10.0	-	V
Supply o		I_{LED}		15.0	20.0	mA

6.2 Interface Signals

6.2.1 CN1 (FPC)

Pin No.	Symbol	Level		Ε	escri	iptio	n		
1	DC	TT/T	PS	MPU1	MPU	J0	MPU inter-face select		
1	PS	H/L	Н	L	L		8080-series 8bit interface		
		/-	Н	L	Н		8080-series 16bit interface		
2	MPU1	H/L	Н	H	L		6800-series 8bit interface 6800-series 16bit interface		
			H L	H L	H X		3 pin SPI(Write only)		
3	MPU0	H/L	L	Н	X		4 pin SPI(Write only)		
4	CS	H/L	Chip	select: L	ow a	ctive	e		
5	RST	H/L	Rese	t pin: Lo	w act	ive			
6	RS	H/L	Index	k register	/ Da	ta co	ommand select		
	HAD (D/HA)	TT/T	6800	-series	F	Read	WRBite control input pin		
7	WR(R/W)	H/L					e enable clock input pin		
0	DD(E)	TT/T	6800-series Read / Write control inp						
8	RD(E)	H/L	8080-series Read enable clock input pin						
9	DB0	H/L							
10	DB1	H/L							
11	DB2	H/L	Data	bus bit 0	-7				
12	DB3	H/L				vali	d in serial interface mode		
13	DB4	H/L	_		•		ance, DB[6]: serial clock,		
14	DB5	H/L	DB[7]: serial	data)).			
15	DB6	H/L							
16	DB7	H/L							
17	DB8	H/L							
18	DB9	H/L							
19	DB10	H/L							
20	DB11	H/L		bus bit 8					
21	DB12	H/L		ect DB lel interf			"low" only in 8-series		
22	DB13	H/L	Parai	101 1111011	u cc 11	iouc	·•		
23	DB14	H/L							
24	DB15	H/L							

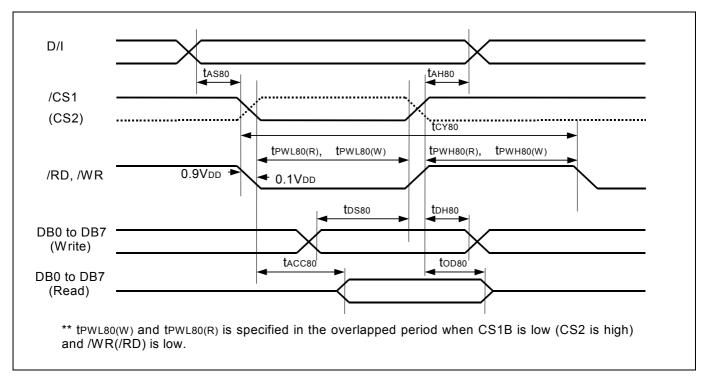
25	VDD	3.0V	Main power supply, 3VDC
26	VSS	0V	Ground

6.2.2 CN2 (LED)

Pin No.	Symbol	Level	Description
1, 2	CATHODE	0V	LED CATHODE
3, 4	ANODE	10.0V	LED ANODE

6.3 Interface Timing Chart

Read / Write Characteristics (8080-series MPU)



Parallel Interface (8080-series MPU) Timing Diagram

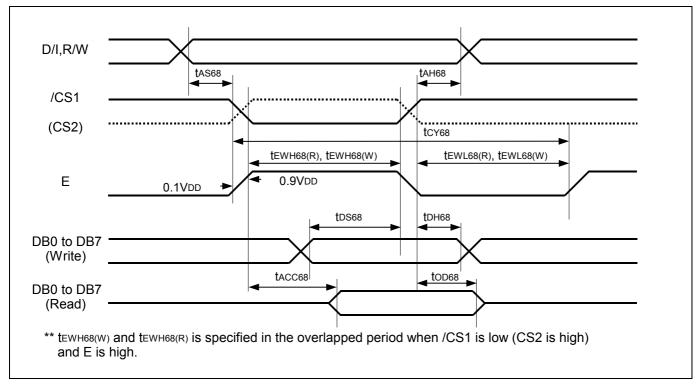
AC Characteristics (8080-series Parallel Mode)

 $(VDD3 = 1.8 \text{ to } 3.3V. \text{ Ta} = -30 \text{ to } +70^{\circ}\text{C})$

(VDD3 = 1.0 to 3.5V, 1a = -50 to 170 to											
Item	Signal	Symbol	Condition	М	in.	Max.	Unit				
item	Signal	Symbol	Symbol		1.8V	(3.3V/1.8V)	Oilit				
Address setup time Address hold time	D/I	t _{AS80} t _{AH80}		0 0	0 0	-	ns				
System cycle time		t _{CY80}		150	360	-	ns				
Pulse width low for write Pulse width High for write	WRB (WRB)	t _{PWLW} t _{PWHW}		50 30	100 75	-	ns				
Pulse width low for read Pulse width high for read	RDB (RDB)	t _{PWLR} t _{PWHR}		50 30	100 75	-	ns				
Data setup time Data hold time	DB0	t _{DS80} t _{DH80}		5 8	10 14	-	ns				
Read access time Output disable time	to DB15	t _{ACC80} t _{OD80}	CL = 100 pF		tEWHR	60 / 120	ns				

NOTE: *1. The input signal rise time and fall time (tr, tf) is specified at 10 ns or less. (tr + tf) < (tcy80 - tpwLw - tpwHw) for write, (tr + tf) < (tcy80 - tpwLR - tpwHR) for read

Read / Write Characteristics (6800-series Microprocessor)



Parallel Interface (6800-series MPU) Timing Diagram

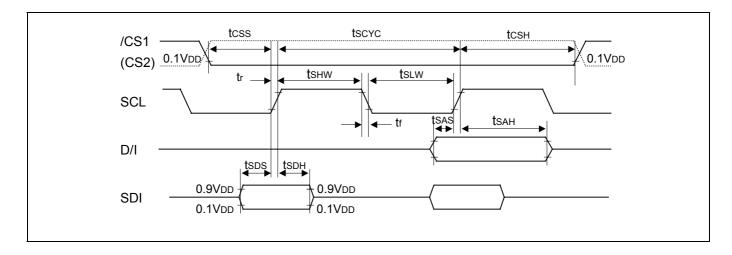
AC Characteristics (6800-series Parallel Mode)

 $(VDD3 = 1.8 \text{ to } 3.3\text{V}, Ta = -30 \text{ to } +70^{\circ}\text{C})$

(VDD3 = 1.8 to 3.5V, 1a = -50 to 170 C											
ltem	Signal	Symbol	Condition	Mi	in.	Max.	Unit				
ILGIII	Signal	Syllibol	Condition	3.3V	1.8 V	(3.3V/1.8V)	Oilit				
Address setup time Address hold time	D/I R/W	tas68 tah68		0 0	0 0	-	ns				
System cycle time		tcY68		150	360	-	ns				
Enable width high for write Enable width low for write	RDB (E)	tewhw tewhw		50 30	100 75		ns				
Enable width high for read Enable width low for read	RDB (E)	tewhr tewlr		50 30	100 75	-	ns				
Data setup time Data hold time	DB0	tDS68 tDH68		5 8	10 14	-	ns				
Read access time Output disable time	to DB15	TACC68 tod68	C _L = 100 pF	- tEWLF		60 / 120	ns				

NOTE: *1. The input signal rise time and fall time (tr, tf) is specified at 10 ns or less. (tr + tf) < (tcy68 - tewhw - tewlw) for write, (tr + tf) < (tcy68 - tewhr - tewlr) for read

Serial Data Interface Timing



Serial Data Interface Timing

 $(VDD3 = 1.8 \text{ to } 3.3V, Ta = -30 \text{ to } +70^{\circ}C)$

Item	Signal	Symbol	Condition	Min.	Max.	Unit
SCL Cycle Time	SCL	tcsc		50	-	ns
SCL High Pulse Width	SCL	t shw		20	-	ns
SCL Low Pulse Width	SCL	tslw		20	-	ns
SDI Setup time	SDI	tsds		20	-	ns
SDI Hold time	SDI	t sdh		20	-	ns
D/I Setup time	D/I	tsas		20	-	ns
D/I Hold time	D/I	t sah		20	-	ns
Chip Select Setup time	CS1B(CS2)	tcss		20	-	ns
Chip Select Hold time	CS1B(CS2)	t chs		20	-	ns

6.4 Instruction code

Instruction Table

IIIstruction rable														
Instruction Name	D/I	WRB	RDB	DB15 ~DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Hex.	Parameter
Non Operation	0	0	1	*	0	0	0	0	0	0	0	0	00	
Oscillation Mode Set	0	0	1	*	0	0	0	0	0	0	1	0	02	1Byte
Driver Output Mode Set	0	0	1	*	0	0	0	1	0	0	0	0	10	1Byte
DC-DC Select	0	0	1	*	0	0	1	0	0	0	0	0	20	1Byte
Bias Set	0	0	1	*	0	0	1	0	0	0	1	0	22	1Byte
DCDC Clock Division Set	0	0	1	*	0	0	1	0	0	1	0	0	24	1Byte
DCDC and AMP ON/OFF set	0	0	1	*	0	0	1	0	0	1	1	0	26	1Byte
Temperature Compensation Set	0	0	1	*	0	0	1	0	1	0	0	0	28	1Byte
Contrast Control(1)	0	0	1	*	0	0	1	0	1	0	1	0	2A	1Byte
Contrast Control(2)	0	0	1	*	0	0	1	0	1	0	1	1	2B	1Byte
Standby Mode OFF	0	0	1	*	0	0	1	0	1	1	0	0	2C	-
Standby Mode ON	0	0	1	*	0	0	1	0	1	1	0	1	2D	-
DDRAM Burst Mode OFF	0	0	1	*	0	0	1	0	1	1	1	0	2E	-
DDRAM Burst Mode ON	0	0	1	*	0	0	1	0	1	1	1	1	2F	-
Addressing Mode Set	0	0	1	*	0	0	1	1	0	0	0	0	30	1Byte
ROW Vector Mode Set	0	0	1	*	0	0	1	1	0	0	1	0	32	1Byte
N-line Inversion Set	0	0	1	*	0	0	1	1	0	1	0	0	34	1Byte
Entry Mode Set	0	0	1	*	0	1	0	0	0	0	0	0	40	1Byte
X-address Area Set	0	0	1	*	0	1	0	0	0	0	1	0	42	2Byte
Y-address Area Set	0	0	1	*	0	1	0	0	0	0	1	1	43	2Byte
RAM Skip Area Set	0	0	1	*	0	1	0	0	0	1	0	1	45	1Byte
Display OFF	0	0	1	*	0	1	0	1	0	0	0	0	50	-
Display ON	0	0	1	*	0	1	0	1	0	0	0	1	51	-
Specified Display Pattern Set	0	0	1	*	0	1	0	1	0	0	1	1	53	1Byte
Partial Display Mode Set	0	0	1	*	0	1	0	1	0	1	0	1	55	1Byte
Partial Display Start Line Set	0	0	1	*	0	1	0	1	0	1	1	0	56	1Byte
Partial Display End Line Set	0	0	1	*	0	1	0	1	0	1	1	1	57	1Byte
Area Scroll Mode Set	0	0	1	*	0	1	0	1	1	0	0	1	59	4Byte
Scroll Start Line Set	0	0	1	*	0	1	0	1	1	0	1	0	5A	1Byte
Set Display Data Length	Х	Х	Х	*	1	1	1	1	1	1	0	0	FC	1Byte
Display Data Write	1	0	1				Displa	ay Data	Write				-	-
Display Data Read	1	1	0		Display Data Read								-	-
Status Read	0	1	0	0	0 Status Data Read							-	-	
Test Mode1	0	0	1	*	1	1	1	1	1	1	1	1	FF	-
Test Mode2 Test Mode3	0	0	1	*	1	1	1	1	1	1	0	0 1	FE FD	-
Test Mode4	0	0	1	*	1	1	1	1	1	0	1	1	FB	-
Test Mode5 Test Mode6	0	0	1	*	1	1	1	1	1	0	0	0 1	FA F9	-

^{*:} Don't care

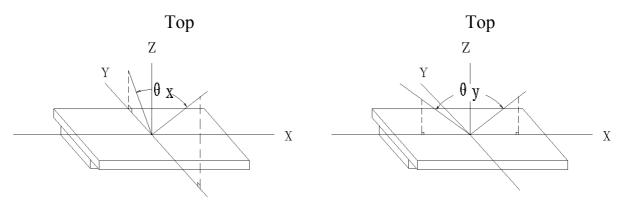
Parameter: The number of parameter bytes that follows instruction data.

7. Optical Characteristics

7.1 Optical	7.1 Optical Characteristics V _{LCD} =1										
Iter	n	Symbol	Coi	ndition	Min.	Тур.	Max.	Unit			
Visionia	A1-	$\theta_{\!\scriptscriptstyle X}$	θ _y =0°		-45	5 +	30	Dag			
Viewing	Angle	θу	- Cr≥2	θ _x =0°	-50	50	Deg				
Contrast	Ratio	Cr		x=0° y=0°	-	30	-				
Response	Turn on	Ton		₄ =0°	-	1	300	ma			
Time	Turn off	Toff	θ	₇ =0°	-	-	200	ms			
	Red	Х	θ,	_i=0°	-	0.53	-	cd/m ²			
Color	Red	у	θ,	√=0°	-	0.37	-				
Of CIE Coord-	Green	X	θ,	≤=0°	-	0.31	-	cd/m ²			
Inate	Giccii	у	в	√=0°	-	0.51	-				
	Dlug	X	θ,	≤=0°	-	0.16	_	cd/m ²			
	Blue	y	θ	√=0°	-	0.18	_				

7.2 Definition of Optical Characteristics

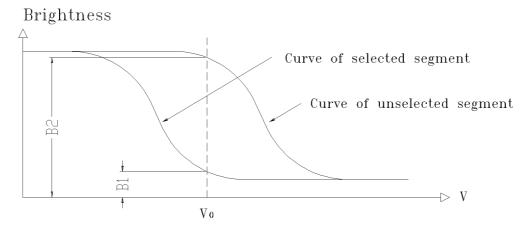
7.2.1 Definition of Viewing Angle



Bottom

n Bottom

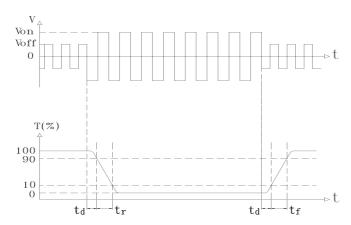
7.2.2 Definition of Contrast Ratio



Contrast Ratio =
$$B2/B1 = \frac{\text{unselected state brightness}}{\text{selected state brightness}}$$

Measuring Conditions:

1) Ambient Temperature: 25℃; 2) Frame frequency: 70.0Hz 7.2.3 Definition of Response time



Turn on time: $t_{on} = t_d + t_r$ Measuring Condition:

Turn off time: $t_{off} = t_d + t_f$

Measuring Condition:

1) Operating Voltage:16.8V 2) Frame frequency: 70.0Hz

7.3 Brightness Characteristic

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Brightness	Вр	Ta=25°C±3°C	100	150	-	cd/m ²
Uniformity	∆Bp	30-80%RH	70	-	-	%

Note:

- 1. The data is measured after LEDs are turned on for 5 minutes.
- 2. Testing conditions LED: $V_{LED} = 10.0 \text{ V (DC)}$ LCD: All dots are on (White color)
- 3. Brightness in the center of the LCD panel.
- 4. Definition of Uniformity (△Bp)

$$\triangle$$
Bp = Bp (Min.) / Bp (Max.) \times 100 (%)

Bp (Max.) = Maximum brightness in 9 measurement spots

Bp (Min.) = Minimum brightness in 9 measurement spots

8. Reliability

8.1 Content of Reliability Test

Ta=25℃

No.	Test Item	Content of Test	Test condition
1	High Temperature	Endurance test applying the high	80°C ±2°C 240H
	Storage	storage temperature for a long time	Restore 4H at 25℃
2	Low Temperature	Endurance test applying the low	-30°C±2°C 240H
2	Storage	storage temperature for a long time	Restore 4H at 25℃
		Endurance test applying the	
3	High Temperature	electric stress (voltage & current)	70°C ±2°C 240H
	Operation	and the thermal stress to the	Restore 4H at 25°C
		element for a long time	
	Low Temperature	Endurance test applying the	-20°C ±2°C
4	Operation	electric stress under low	Restore 4H at 25 ℃
	1	temperature for a long time	
_	High Temperature /Humidity Storage	Endurance test applying the high	70°C ±2°C
5		temperature and high humidity	90%RH 240H
	, ,	storage for a long time	Restore 4H at 25°C
	Temperature Cycle	Endurance test applying the low	• • • • • • • • •
		and high temperature cycle	-30°C/80°C
6		$-30^{\circ}\text{C} \longrightarrow 25^{\circ}\text{C} \longrightarrow 80^{\circ}\text{C} \longrightarrow 25^{\circ}\text{C}$ $30\text{min} 5\text{min} 30\text{min} 5\text{min}$	10 cycles
		←	Restore 4H at 25℃
		1 cycle	Restore 111 at 25 C
	Vibration Test	Endurance test applying the	10Hz~150Hz,
7	(package state)	vibration during transportation	100m/s^2 ,
	(Package state)	violation daring transportation	120min
	Shock Test	Endurance test applying the shock	Half- sine wave,
8	(package state)	during transportation	300m/s^2 ,
			18ms
9	Atmospheric	Endurance test applying the	25kPa 16H
)	Pressure Test	atmospheric pressure during transportation by air	Restore 2H
<u> </u>	1	manaportunon by an	

8.2 Failure Judgment Criterion

Criterion	Test Item No.						0.			Failure Judgment Criterion
Item	1	2	3	4	5	6	7	8	9	Failure Judgment Criterion
Basic Specification	1	V	1	1	V	V	√	~	√	Out of the basic Specification
Electrical specification	1	1	1	1	1					Out of the electrical specification
Mechanical Specification							1	√		Out of the mechanical specification
Optical Characteristic	1	1	1	1	1	1 1		√	Out of the optical specification	
Note For test item refer to 8.1										
Remark	Basic specification = Optical specification + Mechanical specification									

9. Quality Level

Examination	At T _a =25°C	Inspection					
or Test	(unless otherwise stated)	Min.	Max.	Unit	IL	AQL	
External Visual Inspection	Under normal illumination and eyesight condition, the distance between eyes and LCD is 25cm.	e Append	lix A	II	Major 1.0 Minor 2.5		
Display Defects	Under normal illumination and eyesight condition, display on inspection.	See	e Append	lix B	II	Major 1.0 Minor 2.5	

Note: Major defects: Open segment or common, Short, Serious damages, Leakage

Minor defects: Others

Sampling standard conforms to GB2828

10. Precautions for Use of LCD Modules

- 10.1 Handling Precautions
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

- 10.2 Storage precautions
- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature: $0^{\circ}\text{C} \sim 40^{\circ}\text{C}$

Relatively humidity: ≤80%

- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

Appendix A

Inspection items and criteria for appearance defects

Items	Contents	Criteria				
Leakage		Not permitted				
Rainbow		According to the limit specimen				
	Wrong polarizer attachment	Not permitted				
Polarizer	Bubble between	Not counted	Not counted		llowed	
	polarizer and glass	φ<0.3mm		0.3mm≤¢≤0.51	mm	
	Scratches of polarizer	According to the limit specimen				
Black spot	a	Not counted	Max	Max. 3 spots allowed		
(in viewing area)		X<0.2mm	0.2mm≤X≤0.5mm		Max. 3	
		X=(a+b)/2	spots (lines)			
Black line (in viewing		Not counted	Max. 3 lines allowed		allowed	
area)	b	a<0.02mm	0.02mm≤a≤0.05mm b≤2.0mm			
Progressive cracks		Not permitted	I			

Appendix A

Inspection item and criteria for appearance defects (continued)

Items	Contents		Criteria				
	Cracks on pads	a	b	ı	С	Max. 2	
		≤3mm	$\leq V$	V/5	≤T/2	cracks allowed	
	b-y4	≤2mm	≪V	V/5	T/2 <c<t< td=""></c<t<>		
	Cracks on contact side	a			b		
		≤3m	≤3mm		≤T/2		
		≤2m	≤2mm T/2 <b<t< td=""><td></td><td>Mov 5</td></b<t<>			Mov 5	
Glass		C shall be not reach the seal area				Max. 2 cracks	Max. 5 cracks allowed
Cracks	Cracks on non-contact side	a		b		allowed	
	Q Q Q Q Q Q Q Q Q Q Q Q Q Q Q Q Q Q Q	≤3m	m	≪T/2			
		≤2mm		T/2 <b<t< td=""><td></td><td></td></b<t<>			
		C≤0.5mm					
	J"	d≤SW/3	3				
	Corner cracks	e<2.0mm ² f<2.0mm ²			Max. 3 cracks allowed		
	e-1						

Appendix B
Inspection items and criteria for display defects

Items Contents		Contents	Criteria			
Open segmen	nt or ope	n common	Not permitted			
Short			Not permitted			
Wrong view	ing angle	;	Not permitted			
Contrast radi	o uneve	1	According to	the limit specimen		
Crosstalk			According to	the limit specimen		
	. [Not counted	Max.3 dots allowed		
			X<0.1mm	0.1mm≤X≤0.2mm		
Pin holes	a-l-		X=(a+b)/2		Max.3 dots	
and cracks in segment		- - D	Not counted	Max.2 dots allowed	allowed	
(DOT)		1	A<0.1mm	0.1mm≤A≤0.2mm D<0.25mm		
Black spot	snot		Not counted	Max.3 spots allowed		
(in viewing area)			X<0.1mm	0.1mm≤X≤0.2mm		
urcu)	-	a	X=(a+b)/2	Max.3 spots		
Black line	1		Not counted	Max.3 lines allowed	(lines) allowed	
(in viewing area)	t b		a<0.02mm	0.02mm≤a≤0.05mm b≤0.5mm		

Appendix B
Inspection items and criteria for display defects (continued)

Items	Content	Criteria			
	1 0	Not counted	Max. 2 defects allowed		
		x<0.1mm	0.1mm≤x≤0.2mm		
		x=(a+b)/2			
				Max.3 defects	
	D-11-a	Not counted	Max. 1 defects allowed	allowed	
Transfor- mation of segment		a<0.1mm	0.1mm≤a≤0.2mm D>0		
		Max.2 defects 0.8W≤a≤1.2 a=measured va W=nominal va	W alue of width		